

DuPont Kalrez® 8900

For Semiconductor Oxidation, Diffusion, ALD, and LPCVD Applications

Technical Information - March, 2017

Product Description

DuPont® Kalrez® 8900 performance parts are a thick product for oxidation, diffusion, ALD, and LPCVD applications. It offers outstanding thermal stability, very low outgassing and excellent (low) compression set properties. Kalrez® 8900 parts exhibit excellent retention of physical properties at elevated temperatures, have excellent mechanical strength and are well-suited for both static and dynamic sealing applications. A maximum application temperature of 325 °C (617 °F) is suggested. Short excursions to higher temperatures may also be possible. Ultrasonic post-cleaning and packaging is standard for all Kalrez® 8900 parts.



Features/Benefits

- Outstanding thermal stability
- Excellent (low) compression set properties
- Very low outgassing properties
- Very low moisture content
- Excellent retention of physical properties at elevated temperatures
- Excellent resistance to fluorine gas

Suggested Applications

- Quartz Tube Seals
- Plenum Seals
- Chamber Seals
- Filings
- Center Ring Seals

Typical Physical Properties

Color	Black
Hardness ¹ , Shore D (typical static)	70
Hardness ² , Shore M (D-ring)	60
100% Modulus ³ , MPa (psi)	13.33 (2000)
Tensile Strength at Break ⁴ , MPa (psi)	25.04 (3607)
Elongation at Break ⁴ , %	150
Compression Set ⁵ , %	
75 hr. at 204 °C (400 °F)	0
75 hr. at 300 °C (570 °F)	30
75 hr. at 325 °C (617 °F)	50
Max. Application Temperature ⁶ , °C (°F)	325 (617)

¹Measures used in specification section

²ASTM D2240 (see test method)

³ASTM D2952 (see test method)

⁴ASTM D413 (see test method)

⁵ASTM D395 (see test method)

⁶Temperature and time values are for typical conditions

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*Kalrez® 8900 should be used for others specified DVE applications